



**flowNPC 2**

**650 V / 300 A**

**Topology features**

- Capacitor
- Kelvin Emitter for improved switching performance
- Neutral Point Clamped Topology (I-Type)
- Temperature sensor

**Component features**

- High speed and smooth switching
- Low gate charge
- Very low collector emitter saturation voltage

**Housing features**

- Base isolation: Al<sub>2</sub>O<sub>3</sub>
- Convex shaped baseplate for superior thermal contact
- Cu baseplate
- Thermo-mechanical push-and-pull force relief
- Press-fit pin
- Reliable cold welding connection

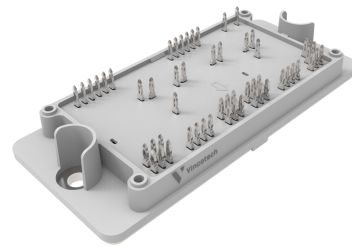
**Target applications**

- Energy Storage Systems
- Industrial Drives
- Solar Inverters
- UPS

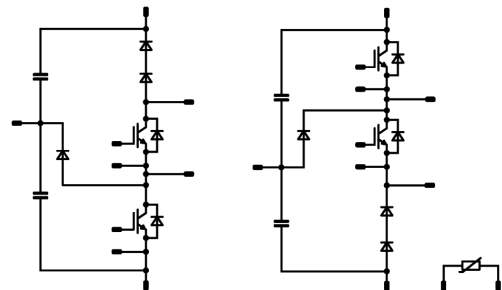
**Types**

- 30-PT07NIB300S503-LH36F58Y

**flow 2 13 mm housing**



**Schematic**





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**30-PT07NIB300S503-LH36F58Y**  
datasheet

## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

| Parameter | Symbol | Conditions | Value | Unit |
|-----------|--------|------------|-------|------|
|-----------|--------|------------|-------|------|

### Buck Switch

|                                   |            |                                       |          |    |
|-----------------------------------|------------|---------------------------------------|----------|----|
| Collector-emitter voltage         | $V_{CES}$  |                                       | 650      | V  |
| Collector current (DC current)    | $I_C$      | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 260      | A  |
| Repetitive peak collector current | $I_{CRM}$  | $t_p$ limited by $T_{jmax}$           | 900      | A  |
| Total power dissipation           | $P_{tot}$  | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 389      | W  |
| Gate-emitter voltage              | $V_{GES}$  |                                       | $\pm 20$ | V  |
| Maximum junction temperature      | $T_{jmax}$ |                                       | 175      | °C |

### Buck Diode

|                                 |            |                                       |     |    |
|---------------------------------|------------|---------------------------------------|-----|----|
| Peak repetitive reverse voltage | $V_{RRM}$  |                                       | 650 | V  |
| Forward current (DC current)    | $I_F$      | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 208 | A  |
| Total power dissipation         | $P_{tot}$  | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 257 | W  |
| Maximum junction temperature    | $T_{jmax}$ |                                       | 175 | °C |

### Buck Sw. Protection Diode

|  |            |  |      |                  |
|--|------------|--|------|------------------|
| Peak repetitive reverse voltage        | $V_{RRM}$  |  | 1200 | V                |
| Forward current (DC current)           | $I_F$      | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$                                | 13   | A                |
| Surge (non-repetitive) forward current | $I_{FSM}$  | Single Half Sine Wave,<br>$t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$ | 36   | A                |
| Surge current capability               | $I^2t$     |  | 6    | A <sup>2</sup> s |
| Total power dissipation                | $P_{tot}$  | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$                                | 35   | W                |
| Maximum junction temperature           | $T_{jmax}$ |  | 175  | °C               |



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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

| Parameter                              | Symbol     | Conditions   | Value       | Unit             |
|--|------------|--|-------------|------------------|
| <b>Boost Switch</b>                    |            |  |             |                  |
| Collector-emitter voltage              | $V_{CES}$  |  | 650         | V                |
| Collector current (DC current)         | $I_C$      | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$                                | 256         | A                |
| Repetitive peak collector current      | $I_{CRM}$  | $t_p$ limited by $T_{jmax}$  | 900         | A                |
| Total power dissipation                | $P_{tot}$  | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$                                | 288         | W                |
| Gate-emitter voltage                   | $V_{GES}$  |  | $\pm 20$    | V                |
| Maximum junction temperature           | $T_{jmax}$ |  | 175         | °C               |
| <b>Boost Diode</b>                     |            |  |             |                  |
| Peak repetitive reverse voltage        | $V_{RRM}$  |  | 1300        | V                |
| Forward current (DC current)           | $I_F$      | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$                                | 182         | A                |
| Total power dissipation                | $P_{tot}$  | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$                                | 461         | W                |
| Maximum junction temperature           | $T_{jmax}$ |  | 175         | °C               |
| <b>Boost Sw. Protection Diode</b>      |            |  |             |                  |
| Peak repetitive reverse voltage        | $V_{RRM}$  |  | 1200        | V                |
| Forward current (DC current)           | $I_F$      | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$                                | 13          | A                |
| Surge (non-repetitive) forward current | $I_{FSM}$  | Single Half Sine Wave,<br>$t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$ | 36          | A                |
| Surge current capability               | $I^2t$     |  | 6           | A <sup>2</sup> s |
| Total power dissipation                | $P_{tot}$  | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$                                | 35          | W                |
| Maximum junction temperature           | $T_{jmax}$ |  | 175         | °C               |
| <b>Capacitor (DC)</b>                  |            |  |             |                  |
| Maximum DC voltage                     | $V_{MAX}$  |  | 630         | V                |
| Operation Temperature                  | $T_{op}$   |  | -55 ... 150 | °C               |



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## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

| Parameter | Symbol | Conditions | Value | Unit |
|-----------|--------|------------|-------|------|
|-----------|--------|------------|-------|------|

### Module Properties

#### Thermal Properties

|   |           |  |                            |    |
|---|-----------|--|----------------------------|----|
| Storage temperature                             | $T_{stg}$ |  | -40...+125                 | °C |
| Operation temperature under switching condition | $T_{jop}$ |  | -40...+( $T_{jmax} - 25$ ) | °C |

#### Isolation Properties

|                            |            |  |       |    |
|----------------------------|------------|--|-------|----|
| Isolation voltage          | $V_{isol}$ | DC Test Voltage*<br>$t_p = 2\text{ s}$ | 6000  | V  |
| Isolation voltage          | $V_{isol}$ | AC Voltage<br>$t_p = 1\text{ min}$     | 2500  | V  |
| Creepage distance          |            |  | >12,7 | mm |
| Clearance                  |            |  | >12,7 | mm |
| Comparative Tracking Index | CTI        |  | ≥ 200 |    |

\*100 % tested in production



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### Characteristic Values

| Parameter | Symbol | Conditions   |              |              |           |            | Values |     |     | Unit |
|-----------|--------|--------------|--------------|--------------|-----------|------------|--------|-----|-----|------|
|           |        | $V_{GS}$ [V] | $V_{GE}$ [V] | $V_{DS}$ [V] | $I_D$ [A] | $T_j$ [°C] | Min    | Typ | Max |      |

#### Buck Switch

##### Static

|                                      |               |                   |    |     |       |                  |     |                      |                     |    |
|--------------------------------------|---------------|-------------------|----|-----|-------|------------------|-----|----------------------|---------------------|----|
| Gate-emitter threshold voltage       | $V_{GE(th)}$  | $V_{CE} = V_{GE}$ |    |     | 0,003 | 25               | 3,2 | 4                    | 4,8                 | V  |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ |                   | 15 |     | 300   | 25<br>125<br>150 |     | 1,43<br>1,52<br>1,55 | 1,75 <sup>(1)</sup> | V  |
| Collector-emitter cut-off current    | $I_{CES}$     |                   | 0  | 650 |       | 25               |     |                      | 200                 | μA |
| Gate-emitter leakage current         | $I_{GES}$     |                   | 20 | 0   |       | 25               |     |                      | 400                 | nA |
| Internal gate resistance             | $r_g$         |                   |    |     |       |                  |     | None                 |                     | Ω  |
| Input capacitance                    | $C_{ies}$     |                   |    |     |       |                  |     | 18000                |                     | pF |
| Output capacitance                   | $C_{oes}$     | $f = 1$ Mhz       | 0  | 25  |       | 25               |     | 520                  |                     | pF |
| Reverse transfer capacitance         | $C_{res}$     |                   |    |     |       |                  |     | 68                   |                     | pF |
| Gate charge                          | $Q_g$         | $V_{CC} = 520$ V  | 15 |     | 300   | 25               |     | 656                  |                     | nC |

##### Thermal

|  |               |                                    |  |  |  |  |  |      |  |     |
|--|---------------|------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink <sup>(2)</sup> | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) |  |  |  |  |  | 0,24 |  | K/W |
|--|---------------|------------------------------------|--|--|--|--|--|------|--|-----|

##### Dynamic

|                             |              |  |  |  |  |                  |  |                           |  |     |
|-----------------------------|--------------|--|--|--|--|------------------|--|---------------------------|--|-----|
| Turn-on delay time          | $t_{d(on)}$  |  |  |  |  | 25<br>125<br>150 |  | 40,47<br>41,02<br>40,95   |  | ns  |
| Rise time                   | $t_r$        |  |  |  |  | 25<br>125<br>150 |  | 17,43<br>18,97<br>19,8    |  | ns  |
| Turn-off delay time         | $t_{d(off)}$ |  |  |  |  | 25<br>125<br>150 |  | 132,96<br>157,81<br>165,3 |  | ns  |
| Fall time                   | $t_f$        |  |  |  |  | 25<br>125<br>150 |  | 21,93<br>28,2<br>31,09    |  | ns  |
| Turn-on energy (per pulse)  | $E_{on}$     | $Q_{tFWD} = 3,1$ μC<br>$Q_{tFWD} = 9,95$ μC<br>$Q_{tFWD} = 12,49$ μC |  |  |  | 25<br>125<br>150 |  | 1,21<br>1,83<br>1,94      |  | mWs |
| Turn-off energy (per pulse) | $E_{off}$    |  |  |  |  | 25<br>125<br>150 |  | 2,22<br>3,52<br>3,88      |  | mWs |



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### Characteristic Values

| Parameter | Symbol | Conditions                   |   |                                     |            |     | Values |     |  | Unit |
|-----------|--------|------------------------------|---|-------------------------------------|------------|-----|--------|-----|--|------|
|           |        | $V_{GE}$ [V]<br>$V_{GS}$ [V] | $V_{CE}$ [V]<br>$V_{DS}$ [V]<br>$V_F$ [V] | $I_C$ [A]<br>$I_D$ [A]<br>$I_F$ [A] | $T_j$ [°C] | Min | Typ    | Max |  |      |

#### Buck Diode

##### Static

|                         |       |               |  |  |     |                  |  |                      |                    |    |
|-------------------------|-------|---------------|--|--|-----|------------------|--|----------------------|--------------------|----|
| Forward voltage         | $V_F$ |               |  |  | 280 | 25<br>125<br>150 |  | 1,73<br>1,45<br>1,41 | 2,5 <sup>(1)</sup> | V  |
| Reverse leakage current | $I_R$ | $V_r = 650$ V |  |  |     | 25               |  |                      | 60                 | μA |

##### Thermal

|  |               |                                       |  |  |  |  |  |      |  |     |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink <sup>(2)</sup> | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK<br>(PSX) |  |  |  |  |  | 0,37 |  | K/W |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|

##### Dynamic

|                                       |                   |   |       |     |     |                  |  |                              |  |      |
|---------------------------------------|-------------------|---|-------|-----|-----|------------------|--|------------------------------|--|------|
| Peak recovery current                 | $I_{RM}$          |   |       |     |     | 25<br>125<br>150 |  | 136,13<br>229,49<br>257,63   |  | A    |
| Reverse recovery time                 | $t_{rr}$          |   |       |     |     | 25<br>125<br>150 |  | 40,8<br>72,91<br>81,66       |  | ns   |
| Recovered charge                      | $Q_r$             | $di/dt=7986$ A/μs<br>$di/dt=7611$ A/μs<br>$di/dt=8106$ A/μs | -5/15 | 350 | 180 | 25<br>125<br>150 |  | 3,1<br>9,95<br>12,49         |  | μC   |
| Reverse recovered energy              | $E_{rec}$         |   |       |     |     | 25<br>125<br>150 |  | 0,612<br>2,11<br>2,68        |  | mWs  |
| Peak rate of fall of recovery current | $(di_r/dt)_{max}$ |   |       |     |     | 25<br>125<br>150 |  | 8271,93<br>6648,6<br>6899,06 |  | A/μs |



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### Characteristic Values

| Parameter | Symbol | Conditions   |              |              |           |            | Values |     |     | Unit |
|-----------|--------|--------------|--------------|--------------|-----------|------------|--------|-----|-----|------|
|           |        | $V_{GS}$ [V] | $V_{GE}$ [V] | $V_{DS}$ [V] | $V_F$ [V] | $T_j$ [°C] | Min    | Typ | Max |      |

#### Buck Sw. Protection Diode

##### Static

|                         |       |                |  |  |   |           |  |              |  |    |
|-------------------------|-------|----------------|--|--|---|-----------|--|--------------|--|----|
| Forward voltage         | $V_F$ |                |  |  | 8 | 25<br>150 |  | 2,37<br>2,27 | 2,65 <sup>(1)</sup><br>2,68 <sup>(1)</sup> | V  |
| Reverse leakage current | $I_R$ | $V_i = 1200$ V |  |  |   | 25<br>150 |  | 0,3          | 0,06<br>0,7                                | mA |

##### Thermal

|  |               |                                    |  |  |  |  |  |      |  |     |
|--|---------------|------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink <sup>(2)</sup> | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK (PSX) |  |  |  |  |  | 2,68 |  | K/W |
|--|---------------|------------------------------------|--|--|--|--|--|------|--|-----|



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### Characteristic Values

| Parameter | Symbol | Conditions   |              |              |           |            | Values |     |     | Unit |
|-----------|--------|--------------|--------------|--------------|-----------|------------|--------|-----|-----|------|
|           |        | $V_{GS}$ [V] | $V_{GE}$ [V] | $V_{DS}$ [V] | $I_C$ [A] | $T_j$ [°C] | Min    | Typ | Max |      |

#### Boost Switch

##### Static

|                                      |               |                   |    |     |       |                  |     |                     |                     |    |
|--------------------------------------|---------------|-------------------|----|-----|-------|------------------|-----|---------------------|---------------------|----|
| Gate-emitter threshold voltage       | $V_{GE(th)}$  | $V_{CE} = V_{GE}$ |    |     | 0,003 | 25               | 4,2 | 5                   | 5,8                 | V  |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ |                   | 15 |     | 225   | 25<br>125<br>150 |     | 1,1<br>1,09<br>1,08 | 1,45 <sup>(1)</sup> | V  |
| Collector-emitter cut-off current    | $I_{CES}$     |                   | 0  | 650 |       | 25               |     |                     | 120                 | μA |
| Gate-emitter leakage current         | $I_{GES}$     |                   | 20 | 0   |       | 25               |     |                     | 360                 | nA |
| Internal gate resistance             | $r_g$         |                   |    |     |       |                  |     | None                |                     | Ω  |
| Input capacitance                    | $C_{ies}$     |                   |    |     |       |                  |     | 36300               |                     | pF |
| Output capacitance                   | $C_{oes}$     | $f = 1$ Mhz       | 0  | 25  |       | 25               |     | 450                 |                     | pF |
| Reverse transfer capacitance         | $C_{res}$     |                   |    |     |       |                  |     | 126                 |                     | pF |
| Gate charge                          | $Q_g$         |                   | 15 | 520 | 225   | 25               |     | 1308                |                     | nC |

##### Thermal

|  |               |                                       |  |  |  |  |  |      |  |     |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink <sup>(2)</sup> | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK<br>(PSX) |  |  |  |  |  | 0,33 |  | K/W |
|--|---------------|---------------------------------------|--|--|--|--|--|------|--|-----|

##### Dynamic

|                             |              |   |  |  |  |                  |  |                            |  |     |
|-----------------------------|--------------|---|--|--|--|------------------|--|----------------------------|--|-----|
| Turn-on delay time          | $t_{d(on)}$  |   |  |  |  | 25<br>125<br>150 |  | 145,02<br>146,44<br>147,1  |  | ns  |
| Rise time                   | $t_r$        |   |  |  |  | 25<br>125<br>150 |  | 16,66<br>17,98<br>18,36    |  | ns  |
| Turn-off delay time         | $t_{d(off)}$ |   |  |  |  | 25<br>125<br>150 |  | 215,32<br>255,29<br>263,64 |  | ns  |
| Fall time                   | $t_f$        |   |  |  |  | 25<br>125<br>150 |  | 33,82<br>117,38<br>170,18  |  | ns  |
| Turn-on energy (per pulse)  | $E_{on}$     | $Q_{tFWD} = 2,58$ μC<br>$Q_{tFWD} = 8,04$ μC<br>$Q_{tFWD} = 10,16$ μC |  |  |  | 25<br>125<br>150 |  | 0,733<br>0,921<br>1        |  | mWs |
| Turn-off energy (per pulse) | $E_{off}$    |   |  |  |  | 25<br>125<br>150 |  | 8,63<br>12,4<br>13,3       |  | mWs |





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datasheet

### Characteristic Values

| Parameter  | Symbol            | Conditions  |   |                                     |            |                  | Values |                                |                  | Unit |
|--|-------------------|---|---|-------------------------------------|------------|------------------|--------|--------------------------------|------------------|------|
|  |                   | $V_{GE}$ [V]<br>$V_{GS}$ [V]                                | $V_{CE}$ [V]<br>$V_{DS}$ [V]<br>$V_F$ [V] | $I_C$ [A]<br>$I_D$ [A]<br>$I_F$ [A] | $T_j$ [°C] | Min              | Typ    | Max                            |                  |      |
| <b>Boost Diode</b>                                 |                   |   |   |                                     |            |                  |        |                                |                  |      |
| <b>Static</b>                                      |                   |   |   |                                     |            |                  |        |                                |                  |      |
| Forward voltage                                    | $V_F$             |   |   |                                     | 280        | 25<br>125<br>150 |        | 4<br>3,33<br>3,17              | 5 <sup>(1)</sup> | V    |
| Reverse leakage current                            | $I_R$             | $V_r = 1300$ V  |   |                                     |            | 25               |        |                                | 60               | μA   |
| <b>Thermal</b>                                     |                   |   |   |                                     |            |                  |        |                                |                  |      |
| Thermal resistance junction to sink <sup>(2)</sup> | $R_{th(j-s)}$     | $\lambda_{paste} = 3,4$ W/mK<br>(PSX)                       |   |                                     |            |                  |        | 0,21                           |                  | K/W  |
| <b>Dynamic</b>                                     |                   |   |   |                                     |            |                  |        |                                |                  |      |
| Peak recovery current                              | $I_{RM}$          |   |   |                                     |            | 25<br>125<br>150 |        | 139,89<br>221,28<br>246,01     |                  | A    |
| Reverse recovery time                              | $t_{rr}$          |   |   |                                     |            | 25<br>125<br>150 |        | 32,28<br>67,84<br>78,27        |                  | ns   |
| Recovered charge                                   | $Q_r$             | $di/dt=9038$ A/μs<br>$di/dt=8691$ A/μs<br>$di/dt=8303$ A/μs | ±15                                       | 350                                 | 180        | 25<br>125<br>150 |        | 2,58<br>8,04<br>10,16          |                  | μC   |
| Reverse recovered energy                           | $E_{rec}$         |   |   |                                     |            | 25<br>125<br>150 |        | 0,398<br>1,63<br>2,09          |                  | mWs  |
| Peak rate of fall of recovery current              | $(di_r/dt)_{max}$ |   |   |                                     |            | 25<br>125<br>150 |        | 13929,49<br>9977,38<br>9746,69 |                  | A/μs |



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### Characteristic Values

| Parameter | Symbol | Conditions                   |   |                                     |            |     | Values |     |  | Unit |
|-----------|--------|------------------------------|---|-------------------------------------|------------|-----|--------|-----|--|------|
|           |        | $V_{GE}$ [V]<br>$V_{GS}$ [V] | $V_{CE}$ [V]<br>$V_{DS}$ [V]<br>$V_F$ [V] | $I_C$ [A]<br>$I_D$ [A]<br>$I_F$ [A] | $T_j$ [°C] | Min | Typ    | Max |  |      |

#### Boost Sw. Protection Diode

##### Static

|                         |       |                |  |   |           |  |              |  |    |
|-------------------------|-------|----------------|--|---|-----------|--|--------------|--|----|
| Forward voltage         | $V_F$ |                |  | 8 | 25<br>150 |  | 2,37<br>2,27 | 2,65 <sup>(1)</sup><br>2,68 <sup>(1)</sup> | V  |
| Reverse leakage current | $I_R$ | $V_i = 1200$ V |  |   | 25<br>150 |  | 0,3          | 0,06<br>0,7                                | mA |

##### Thermal

|  |               |                                       |  |  |  |  |      |  |     |
|--|---------------|---------------------------------------|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink <sup>(2)</sup> | $R_{th(j-s)}$ | $\lambda_{paste} = 3,4$ W/mK<br>(PSX) |  |  |  |  | 2,68 |  | K/W |
|--|---------------|---------------------------------------|--|--|--|--|------|--|-----|

#### Capacitor (DC)

##### Static

|             |     |                          |  |  |    |    |    |   |    |
|-------------|-----|--------------------------|--|--|----|----|----|---|----|
| Capacitance | $C$ | DC bias voltage =<br>0 V |  |  | 25 |    | 33 |   | nF |
| Tolerance   |     |                          |  |  |    | -5 |    | 5 | %  |

#### Thermistor

##### Static

|                                |                |                    |  |  |     |    |      |   |      |
|--------------------------------|----------------|--------------------|--|--|-----|----|------|---|------|
| Rated resistance               | $R$            |                    |  |  | 25  |    | 22   |   | kΩ   |
| Deviation of R100              | $\Delta_{R/R}$ | $R_{100} = 1484$ Ω |  |  | 100 | -5 |      | 5 | %    |
| Power dissipation              | $P$            |                    |  |  | 25  |    | 130  |   | mW   |
| Power dissipation constant     | $d$            |                    |  |  | 25  |    | 1,5  |   | mW/K |
| B-value                        | $B_{(25/50)}$  | Tol. $\pm 1$ %     |  |  |     |    | 3962 |   | K    |
| B-value                        | $B_{(25/100)}$ | Tol. $\pm 1$ %     |  |  |     |    | 4000 |   | K    |
| Vincotech Thermistor Reference |                |                    |  |  |     |    |      | I |      |

<sup>(1)</sup> Value at chip level

<sup>(2)</sup> Only valid with pre-applied Vincotech thermal interface material.

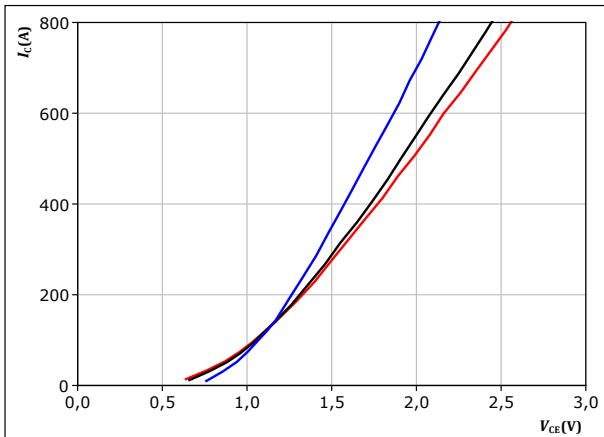


## Buck Switch Characteristics

**figure 1.** IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



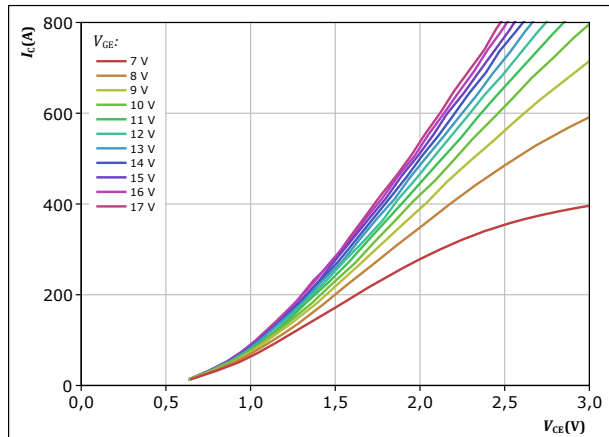
$t_p = 250 \mu s$   
 $V_{GE} = 15 V$

$T_j:$  — 25 °C  
— 125 °C  
— 150 °C

**figure 2.** IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

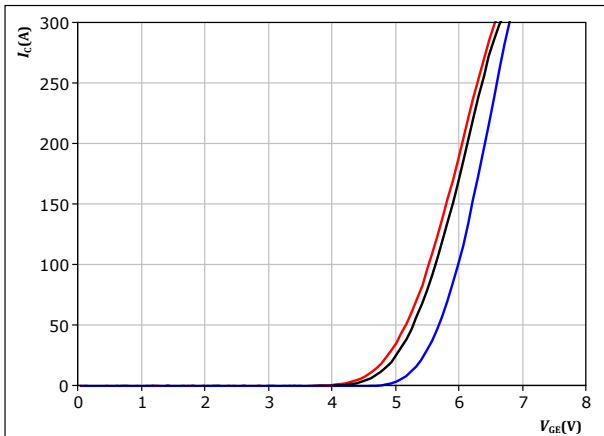


$t_p = 250 \mu s$   
 $T_j = 150 \text{ } ^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 3.** IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$



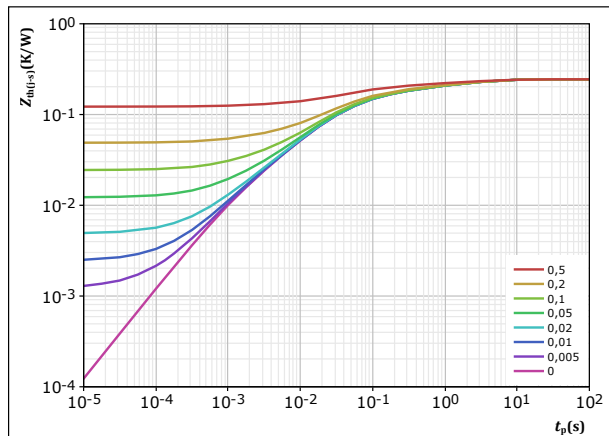
$t_p = 250 \mu s$   
 $V_{CE} = 10 V$

$T_j:$  — 25 °C  
— 125 °C  
— 150 °C

**figure 4.** IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 0,244 \text{ K/W}$

IGBT thermal model values

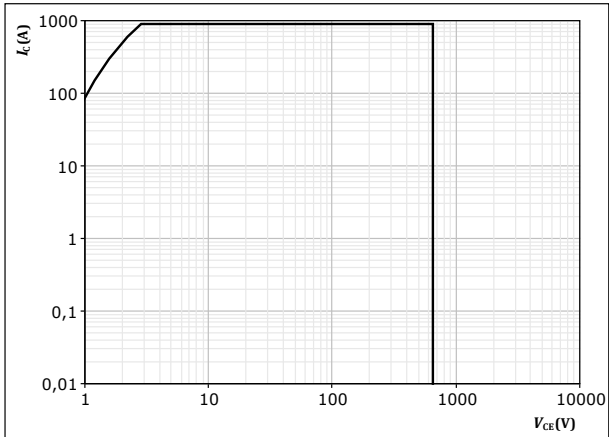
| $R$ (K/W) | $\tau$ (s) |
|-----------|------------|
| 3,19E-02  | 4,04E+00   |
| 3,56E-02  | 8,39E-01   |
| 5,47E-02  | 1,56E-01   |
| 9,39E-02  | 3,22E-02   |
| 2,10E-02  | 7,54E-03   |
| 7,41E-03  | 1,20E-03   |



### Buck Switch Characteristics

figure 5. IGBT

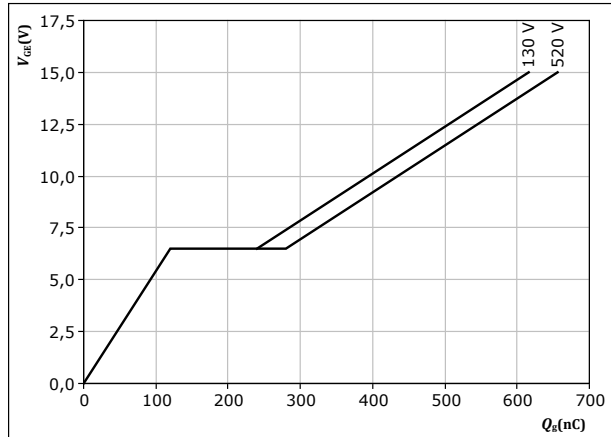
Safe operating area  
 $I_C = f(V_{CE})$



$D =$  single pulse  
 $T_s = 80$  °C  
 $V_{GE} = 15$  V  
 $T_j = T_{jmax}$

figure 6. IGBT

Gate voltage vs gate charge  
 $V_{GE} = f(Q_g)$



$I_C = 75$  A  
 $T_j = 25$  °C



### Buck Diode Characteristics

figure 7. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

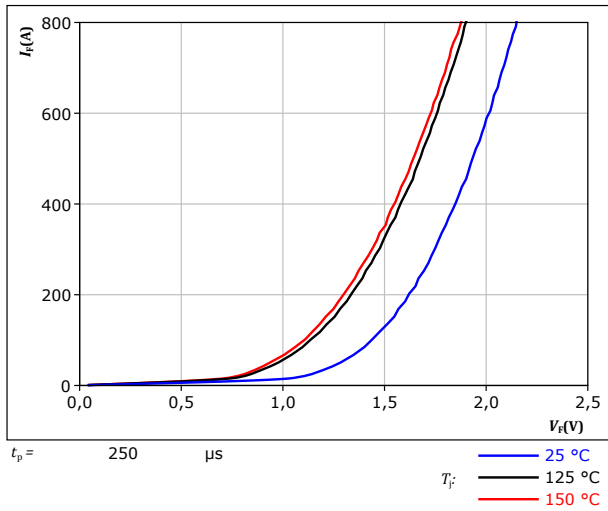
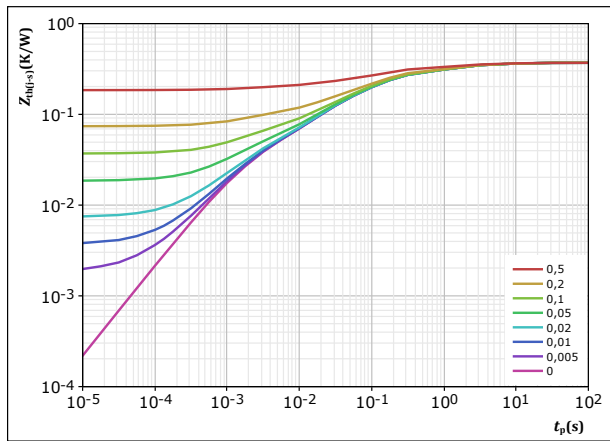


figure 8. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 0,37$  K/W  
 FWD thermal model values

| $R$ (K/W) | $\tau$ (s) |
|-----------|------------|
| 1,90E-02  | 9,17E+00   |
| 8,58E-02  | 1,35E+00   |
| 1,71E-01  | 1,16E-01   |
| 6,65E-02  | 1,86E-02   |
| 2,75E-02  | 1,64E-03   |



## Buck Sw. Protection Diode Characteristics

figure 9. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

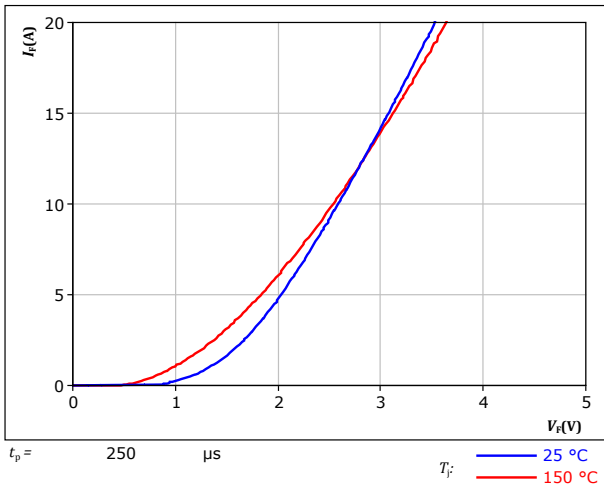
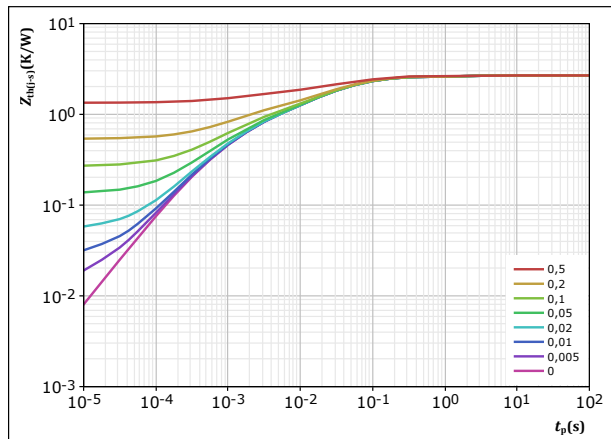


figure 10. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



|                          |            |     |
|--------------------------|------------|-----|
| $D =$                    | $t_p / T$  |     |
| $R_{th(j-s)} =$          | 2,683      | K/W |
| FWD thermal model values |            |     |
| $R$ (K/W)                | $\tau$ (s) |     |
| 1,24E-01                 | 1,82E+00   |     |
| 9,92E-01                 | 7,02E-02   |     |
| 8,59E-01                 | 1,48E-02   |     |
| 5,29E-01                 | 1,78E-03   |     |
| 1,79E-01                 | 4,06E-04   |     |

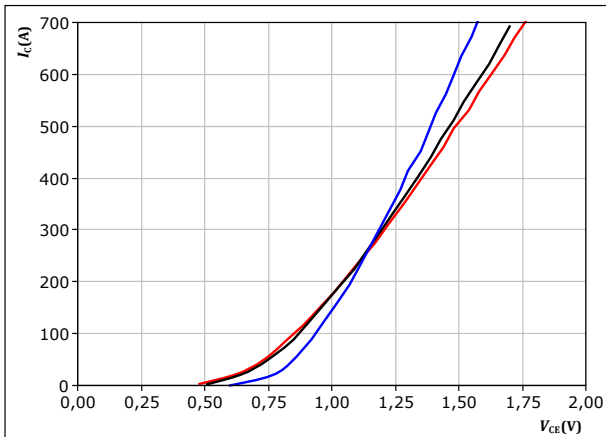


## Boost Switch Characteristics

**figure 11.** IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



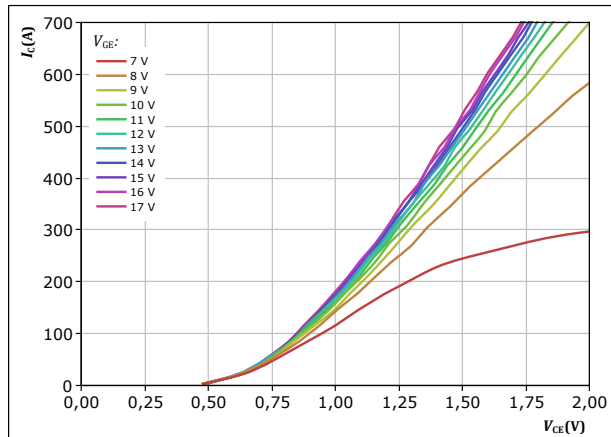
$t_p = 250 \mu s$   
 $V_{GE} = 15 V$

$T_j:$  — 25 °C  
— 125 °C  
— 150 °C

**figure 12.** IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

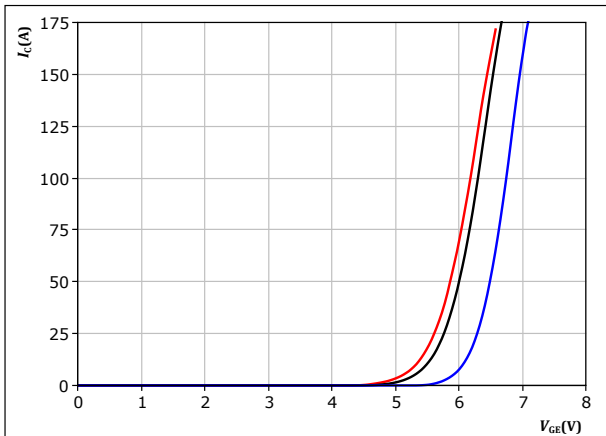


$t_p = 250 \mu s$   
 $T_j = 150 \text{ °C}$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**figure 13.** IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$



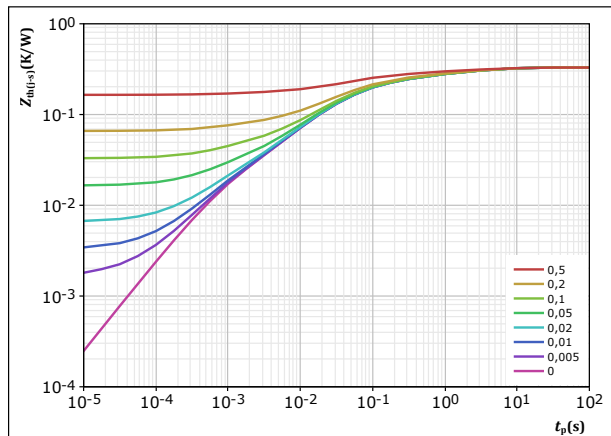
$t_p = 250 \mu s$   
 $V_{CE} = 10 V$

$T_j:$  — 25 °C  
— 125 °C  
— 150 °C

**figure 14.** IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 0,329 \text{ K/W}$

IGBT thermal model values

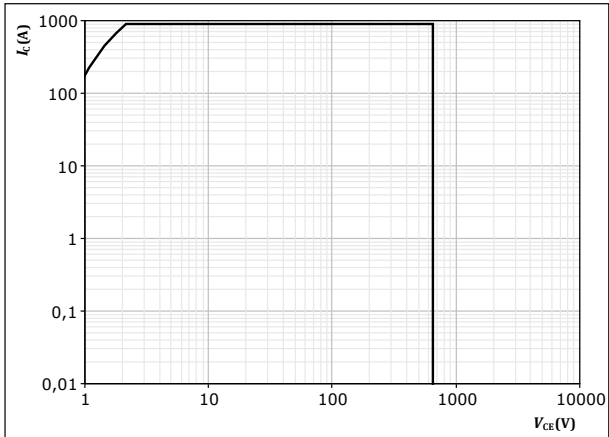
| $R$ (K/W) | $\tau$ (s) |
|-----------|------------|
| 3,80E-02  | 5,19E+00   |
| 4,42E-02  | 1,12E+00   |
| 8,02E-02  | 1,82E-01   |
| 1,26E-01  | 3,39E-02   |
| 2,79E-02  | 6,91E-03   |
| 1,28E-02  | 7,70E-04   |



### Boost Switch Characteristics

figure 15. IGBT

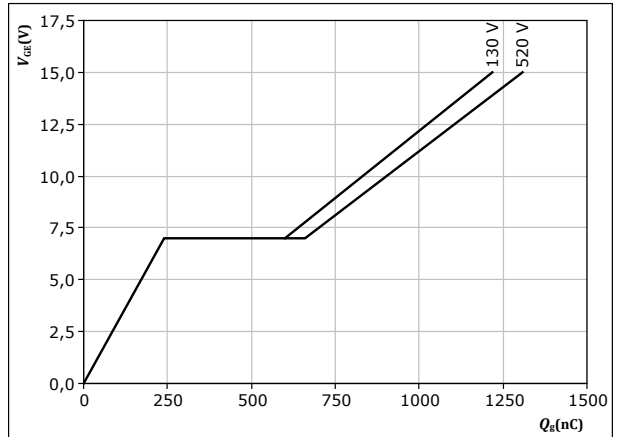
Safe operating area  
 $I_C = f(V_{CE})$



$D =$  single pulse  
 $T_s = 80$  °C  
 $V_{GE} = 15$  V  
 $T_j = T_{jmax}$

figure 16. IGBT

Gate voltage vs gate charge  
 $V_{GE} = f(Q_g)$



$I_C = 75$  A  
 $T_j = 25$  °C





### Boost Diode Characteristics

figure 17. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

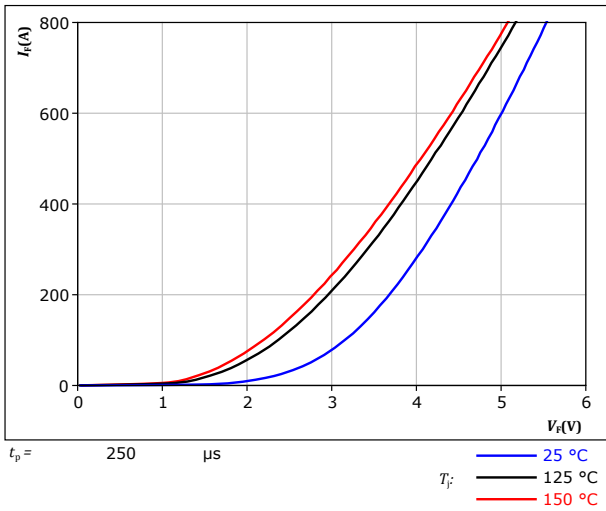
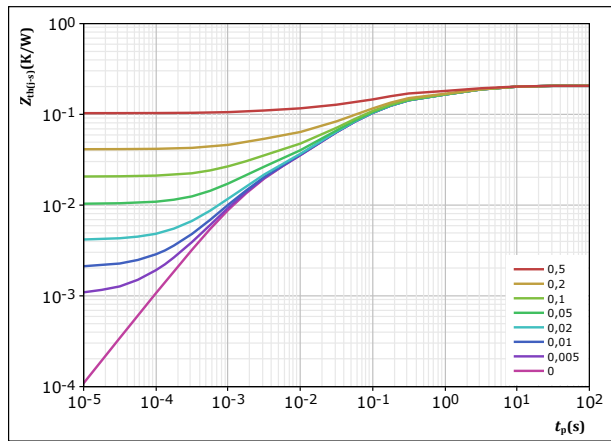


figure 18. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 0,206 \text{ K/W}$   
 FWD thermal model values

| R (K/W)  | $\tau$ (s) |
|----------|------------|
| 2,74E-02 | 5,35E+00   |
| 4,37E-02 | 1,14E+00   |
| 9,32E-02 | 1,04E-01   |
| 2,79E-02 | 1,70E-02   |
| 1,41E-02 | 1,69E-03   |

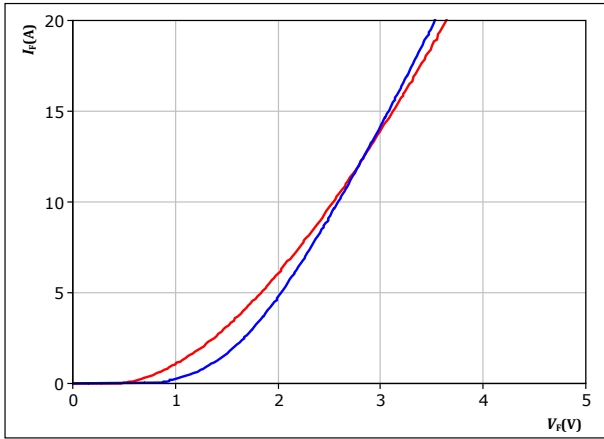


### Boost Sw. Protection Diode Characteristics

figure 19. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

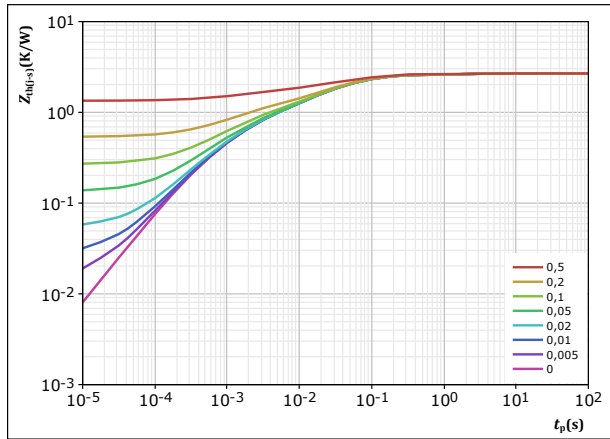


$t_p = 250 \mu s$   
 $T_j: 25 \text{ }^\circ\text{C}$  (blue line)  
 $150 \text{ }^\circ\text{C}$  (red line)

figure 20. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$   
 $R_{th(j-s)} = 2,683 \text{ K/W}$   
 FWD thermal model values

| $R \text{ (K/W)}$ | $\tau \text{ (s)}$ |
|-------------------|--------------------|
| 1,24E-01          | 1,82E+00           |
| 9,92E-01          | 7,02E-02           |
| 8,59E-01          | 1,48E-02           |
| 5,29E-01          | 1,78E-03           |
| 1,79E-01          | 4,06E-04           |

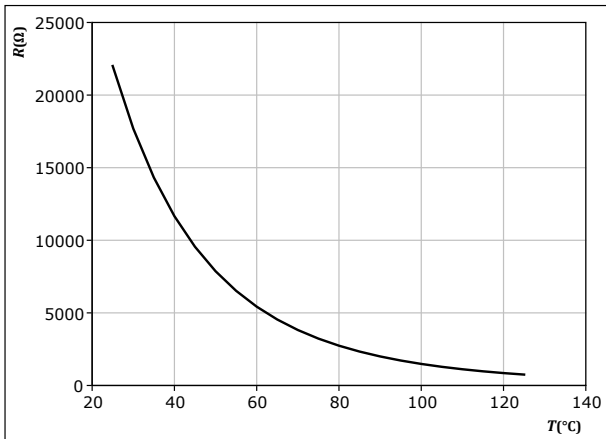


### Thermistor Characteristics

figure 21. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$

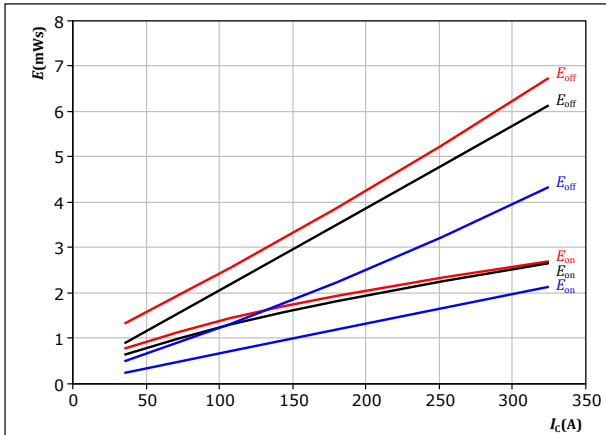




## Buck Switching Characteristics

**figure 22.** IGBT

Typical switching energy losses as a function of collector current  
 $E = f(I_c)$

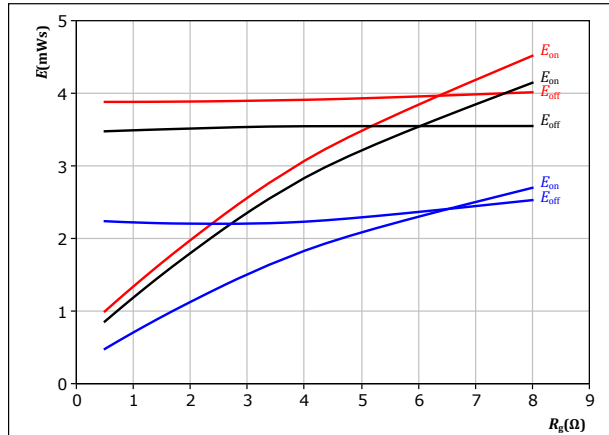


With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 2$   $\Omega$   
 $R_{goff} = 2$   $\Omega$

$T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)

**figure 23.** IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor  
 $E = f(R_g)$

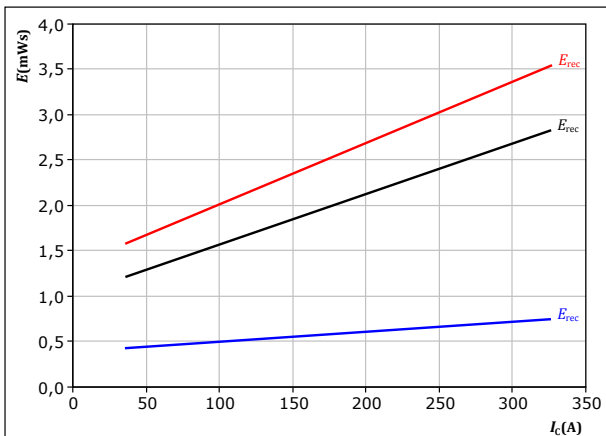


With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $I_c = 180$  A

$T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)

**figure 24.** FWD

Typical reverse recovered energy loss as a function of collector current  
 $E_{rec} = f(I_c)$

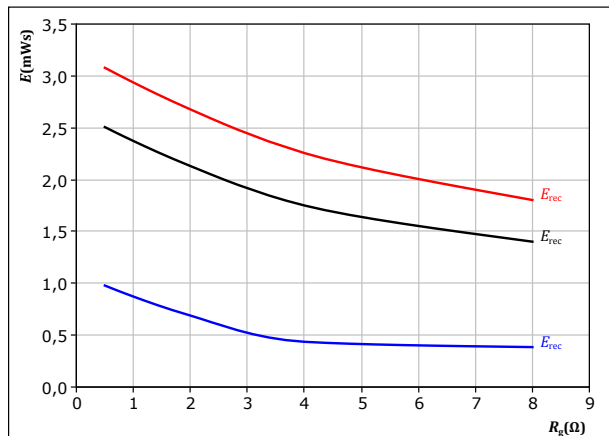


With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 2$   $\Omega$

$T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)

**figure 25.** FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor  
 $E_{rec} = f(R_g)$



With an inductive load at  
 $V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $I_c = 180$  A

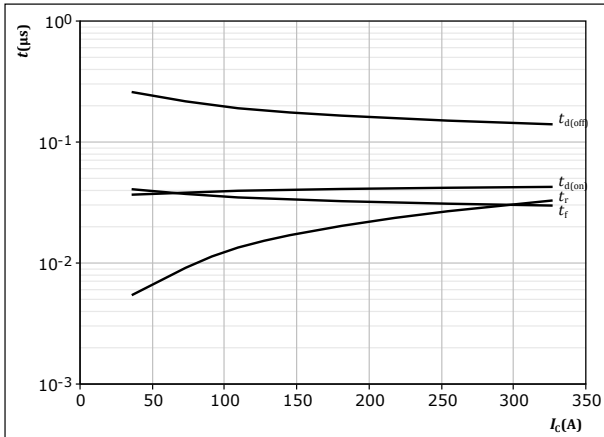
$T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)



## Buck Switching Characteristics

**figure 26.** IGBT

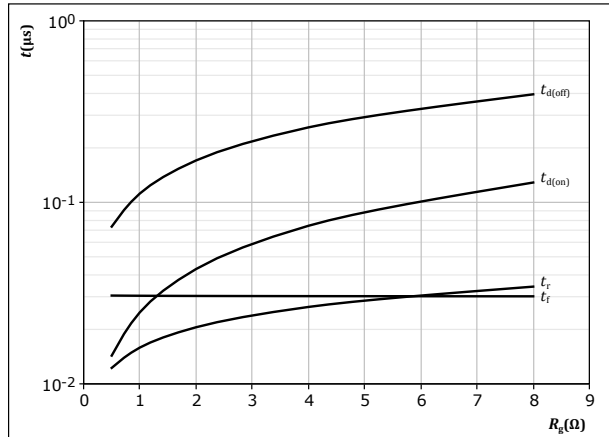
Typical switching times as a function of collector current  
 $t = f(I_c)$



With an inductive load at  
 $T_j = 150 \text{ }^\circ\text{C}$   
 $V_{CE} = 350 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $R_{gon} = 2 \text{ } \Omega$   
 $R_{goff} = 2 \text{ } \Omega$

**figure 27.** IGBT

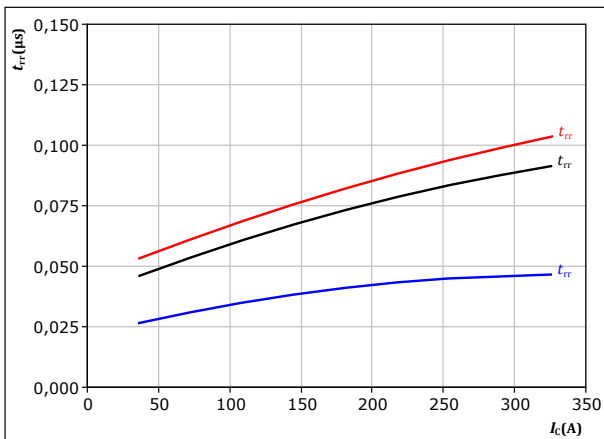
Typical switching times as a function of IGBT turn on gate resistor  
 $t = f(R_g)$



With an inductive load at  
 $T_j = 150 \text{ }^\circ\text{C}$   
 $V_{CE} = 350 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $I_c = 180 \text{ A}$

**figure 28.** FWD

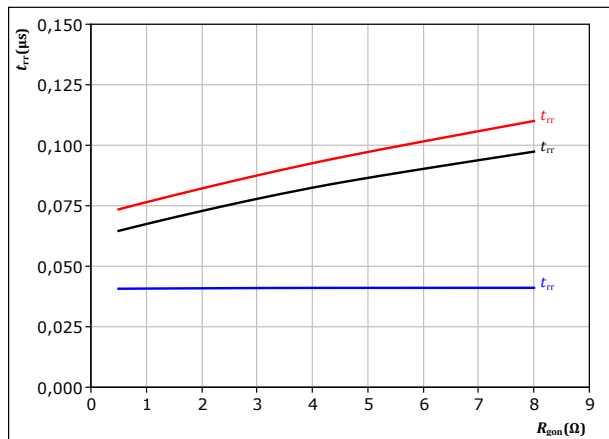
Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_c)$



With an inductive load at  
 $V_{CE} = 350 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $R_{gon} = 2 \text{ } \Omega$   
 $T_j:$  — 25 °C  
— 125 °C  
— 150 °C

**figure 29.** FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor  
 $t_{rr} = f(R_{gon})$



With an inductive load at  
 $V_{CE} = 350 \text{ V}$   
 $V_{GE} = -5/15 \text{ V}$   
 $I_c = 180 \text{ A}$   
 $T_j:$  — 25 °C  
— 125 °C  
— 150 °C

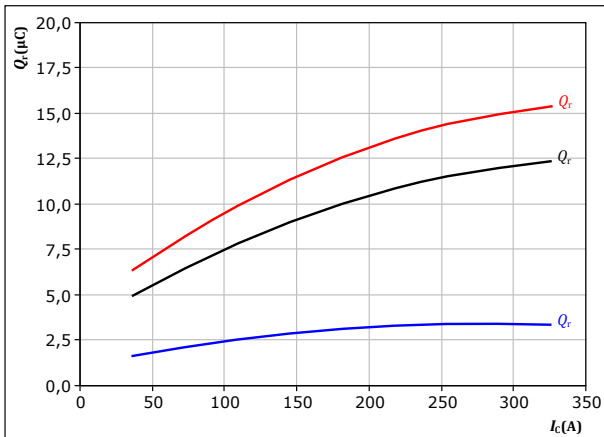


## Buck Switching Characteristics

**figure 30.** FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



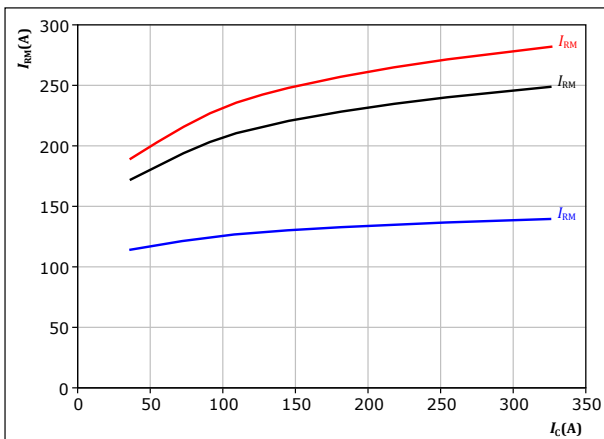
With an inductive load at

$V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 2$  Ω  
 $T_j:$  — 25 °C  
           — 125 °C  
           — 150 °C

**figure 32.** FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



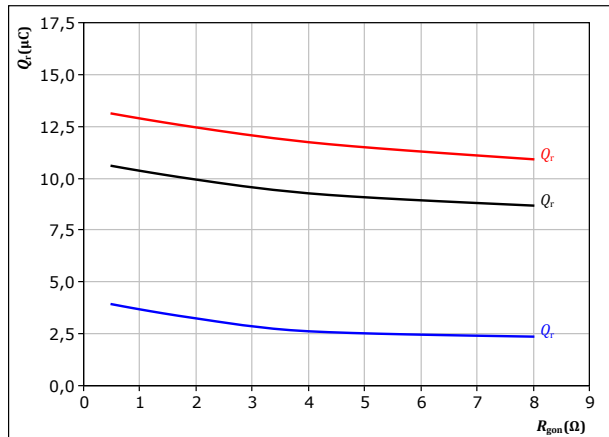
With an inductive load at

$V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 2$  Ω  
 $T_j:$  — 25 °C  
           — 125 °C  
           — 150 °C

**figure 31.** FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



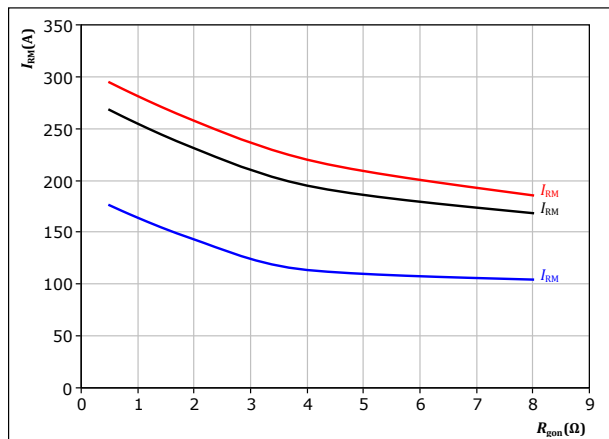
With an inductive load at

$V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $I_c = 180$  A  
 $T_j:$  — 25 °C  
           — 125 °C  
           — 150 °C

**figure 33.** FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

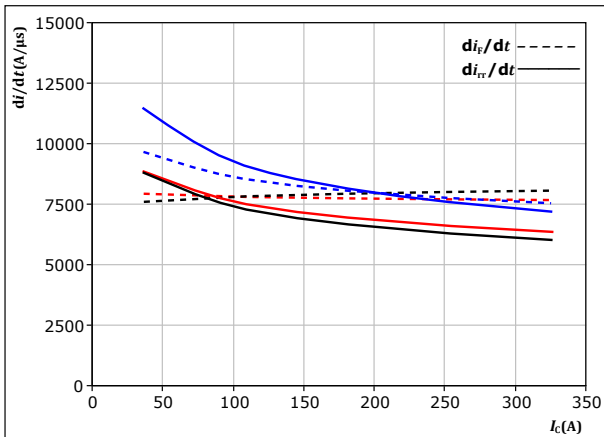
$V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $I_c = 180$  A  
 $T_j:$  — 25 °C  
           — 125 °C  
           — 150 °C



## Buck Switching Characteristics

**figure 34.** FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_{rr}/dt = f(I_c)$



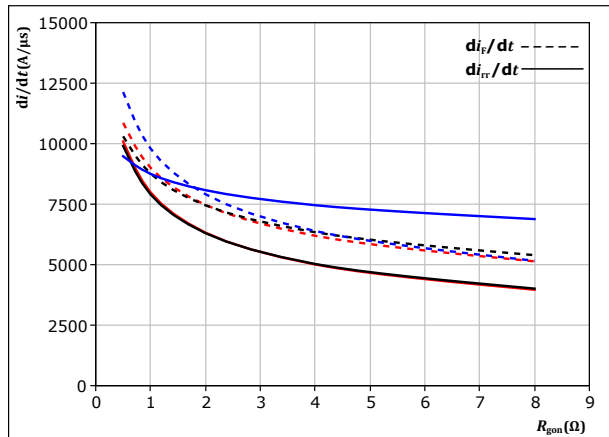
With an inductive load at

$V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $R_{gon} = 2$  Ω

$T_j$ : 25 °C  
 125 °C  
 150 °C

**figure 35.** FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor  
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at

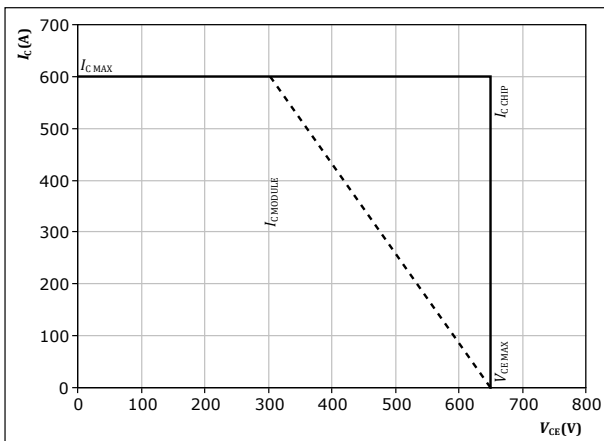
$V_{CE} = 350$  V  
 $V_{GE} = -5/15$  V  
 $I_c = 180$  A

$T_j$ : 25 °C  
 125 °C  
 150 °C

**figure 36.** IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



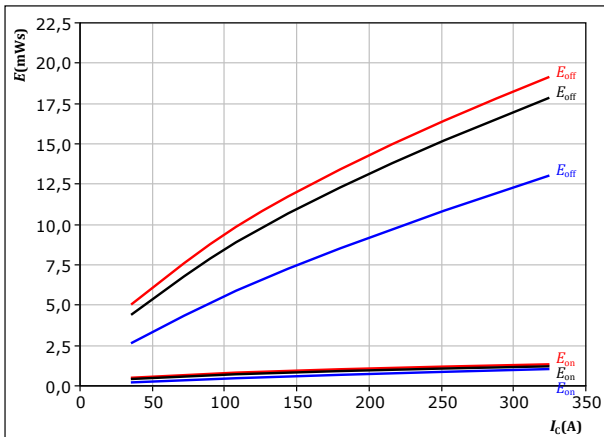
At  $T_j = 150$  °C  
 $R_{gon} = 2$  Ω  
 $R_{goff} = 2$  Ω



## Boost Switching Characteristics

**figure 37.** IGBT

Typical switching energy losses as a function of collector current  
 $E = f(I_c)$

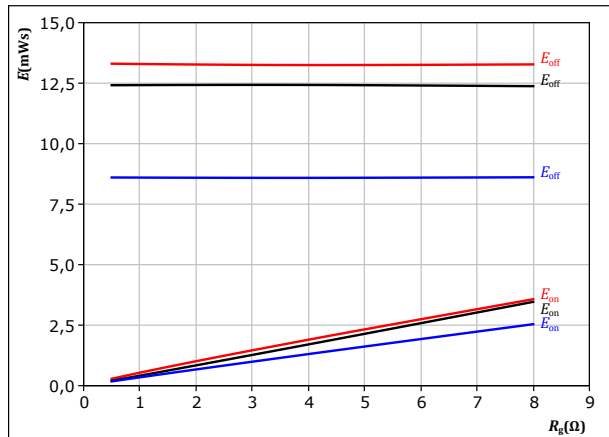


With an inductive load at

|                     |                |
|---------------------|----------------|
| $V_{CE} = 350$ V    | $T_j = 25$ °C  |
| $V_{GE} = \pm 15$ V | $T_j = 125$ °C |
| $R_{gon} = 2$ Ω     | $T_j = 150$ °C |
| $R_{goff} = 2$ Ω    |                |

**figure 38.** IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor  
 $E = f(R_g)$

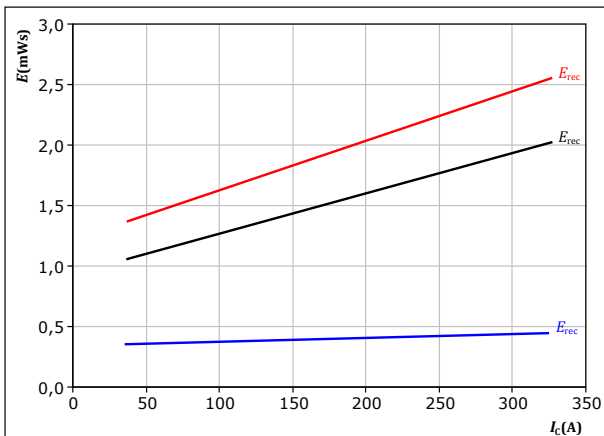


With an inductive load at

|                     |                |
|---------------------|----------------|
| $V_{CE} = 350$ V    | $T_j = 25$ °C  |
| $V_{GE} = \pm 15$ V | $T_j = 125$ °C |
| $I_c = 180$ A       | $T_j = 150$ °C |

**figure 39.** FWD

Typical reverse recovered energy loss as a function of collector current  
 $E_{rec} = f(I_c)$

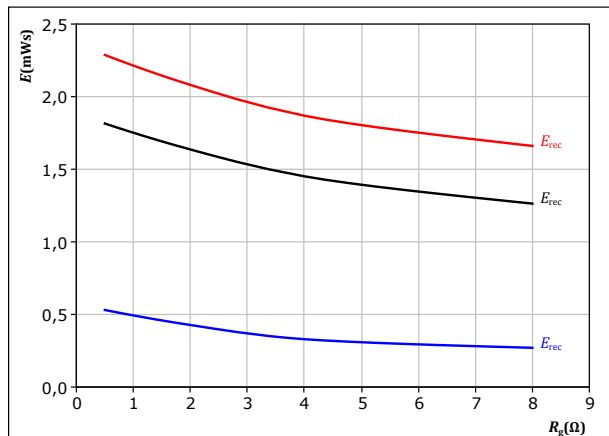


With an inductive load at

|                     |                |
|---------------------|----------------|
| $V_{CE} = 350$ V    | $T_j = 25$ °C  |
| $V_{GE} = \pm 15$ V | $T_j = 125$ °C |
| $R_{gon} = 2$ Ω     | $T_j = 150$ °C |

**figure 40.** FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor  
 $E_{rec} = f(R_g)$



With an inductive load at

|                     |                |
|---------------------|----------------|
| $V_{CE} = 350$ V    | $T_j = 25$ °C  |
| $V_{GE} = \pm 15$ V | $T_j = 125$ °C |
| $I_c = 180$ A       | $T_j = 150$ °C |

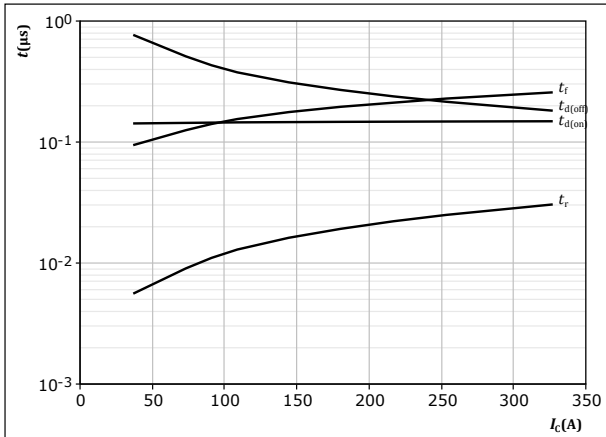




## Boost Switching Characteristics

**figure 41.** IGBT

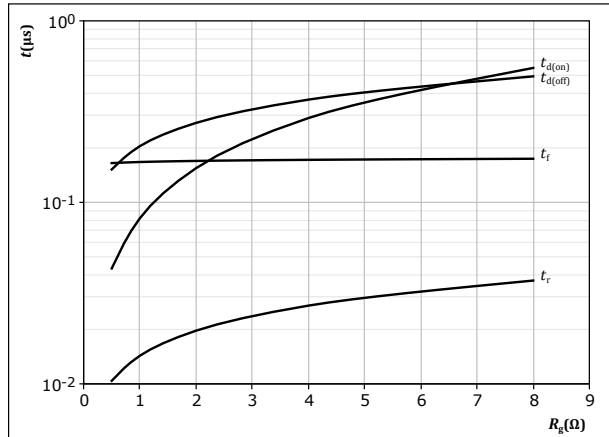
Typical switching times as a function of collector current  
 $t = f(I_c)$



With an inductive load at  
 $T_j = 150 \text{ }^\circ\text{C}$   
 $V_{CE} = 350 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \text{ } \Omega$   
 $R_{goff} = 2 \text{ } \Omega$

**figure 42.** IGBT

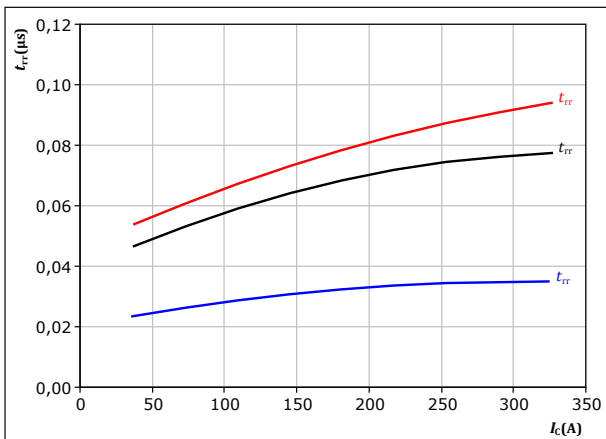
Typical switching times as a function of IGBT turn on gate resistor  
 $t = f(R_g)$



With an inductive load at  
 $T_j = 150 \text{ }^\circ\text{C}$   
 $V_{CE} = 350 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_c = 180 \text{ A}$

**figure 43.** FWD

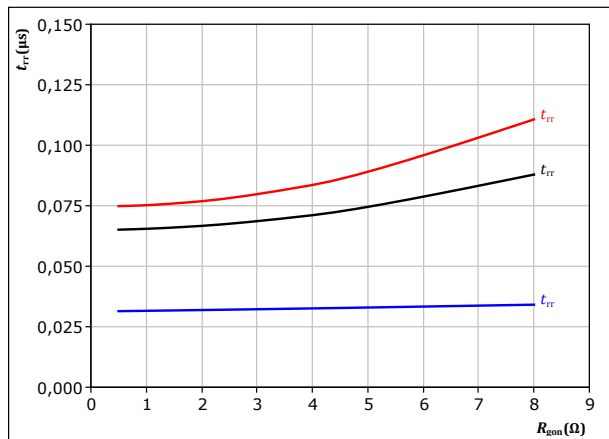
Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_c)$



With an inductive load at  
 $V_{CE} = 350 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \text{ } \Omega$   
 $T_j:$  — 25 °C  
 — 125 °C  
 — 150 °C

**figure 44.** FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor  
 $t_{rr} = f(R_{gon})$



With an inductive load at  
 $V_{CE} = 350 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_c = 180 \text{ A}$   
 $T_j:$  — 25 °C  
 — 125 °C  
 — 150 °C

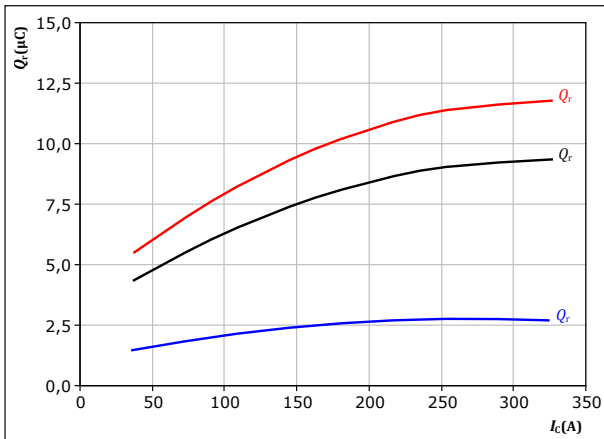


## Boost Switching Characteristics

figure 45. FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

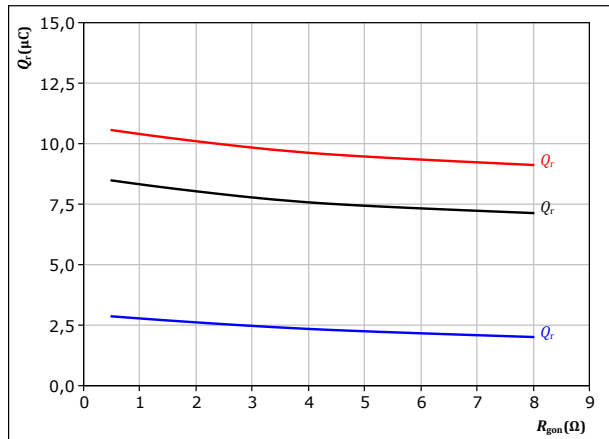
$V_{CE} = 350 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \text{ } \Omega$

$T_j$ :  $25 \text{ } ^\circ\text{C}$  (blue)  
 $125 \text{ } ^\circ\text{C}$  (black)  
 $150 \text{ } ^\circ\text{C}$  (red)

figure 46. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

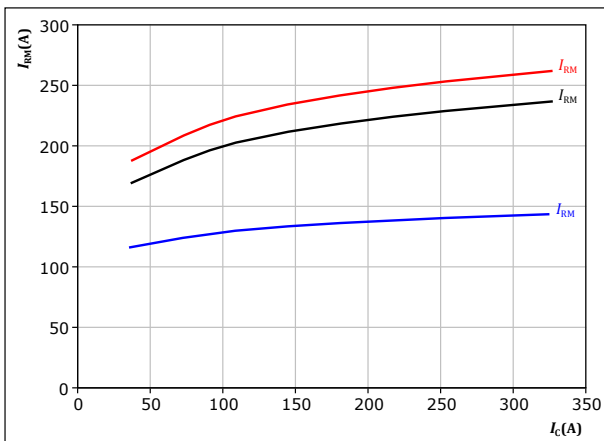
$V_{CE} = 350 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_c = 180 \text{ A}$

$T_j$ :  $25 \text{ } ^\circ\text{C}$  (blue)  
 $125 \text{ } ^\circ\text{C}$  (black)  
 $150 \text{ } ^\circ\text{C}$  (red)

figure 47. FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

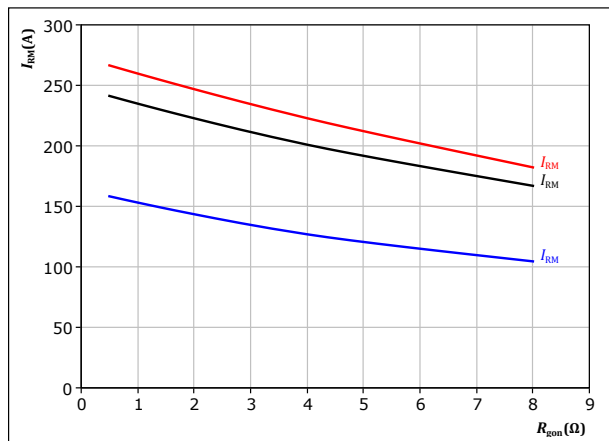
$V_{CE} = 350 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \text{ } \Omega$

$T_j$ :  $25 \text{ } ^\circ\text{C}$  (blue)  
 $125 \text{ } ^\circ\text{C}$  (black)  
 $150 \text{ } ^\circ\text{C}$  (red)

figure 48. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$V_{CE} = 350 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_c = 180 \text{ A}$

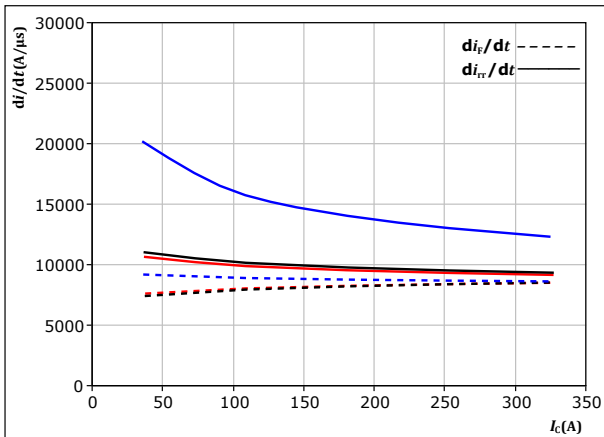
$T_j$ :  $25 \text{ } ^\circ\text{C}$  (blue)  
 $125 \text{ } ^\circ\text{C}$  (black)  
 $150 \text{ } ^\circ\text{C}$  (red)



## Boost Switching Characteristics

**figure 49.** FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_r/dt = f(I_c)$



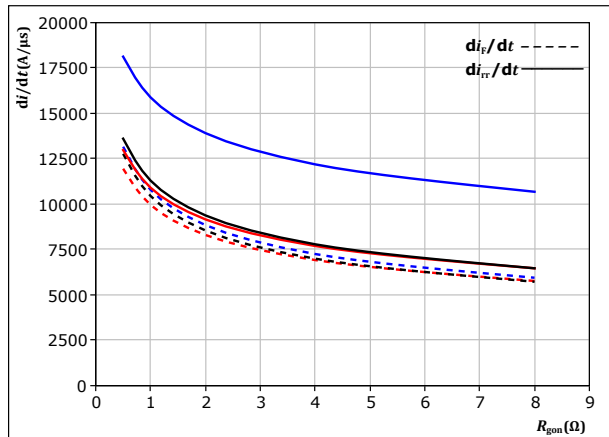
With an inductive load at

$V_{CE} = 350$  V  
 $V_{GE} = \pm 15$  V  
 $R_{gon} = 2$   $\Omega$

$T_j$ : — 25 °C  
 — 125 °C  
 — 150 °C

**figure 50.** FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor  
 $di_f/dt, di_r/dt = f(R_{gon})$



With an inductive load at

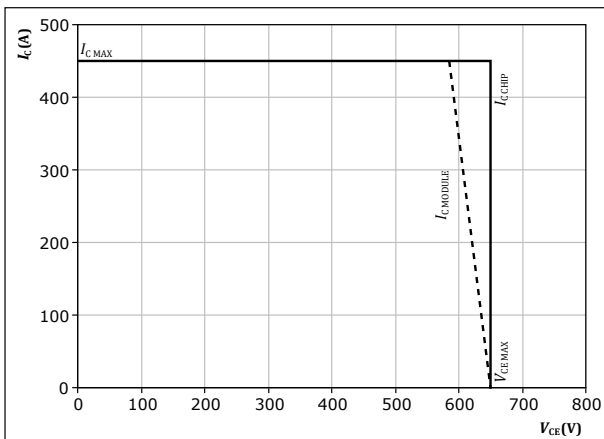
$V_{CE} = 350$  V  
 $V_{GE} = \pm 15$  V  
 $I_c = 180$  A

$T_j$ : — 25 °C  
 — 125 °C  
 — 150 °C

**figure 51.** IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At  $T_j = 150$  °C  
 $R_{gon} = 2$   $\Omega$   
 $R_{goff} = 2$   $\Omega$



## Switching Definitions

figure 52. IGBT

Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )

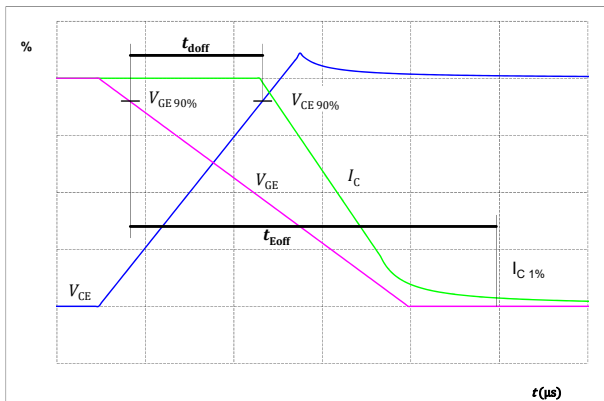


figure 53. IGBT

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )

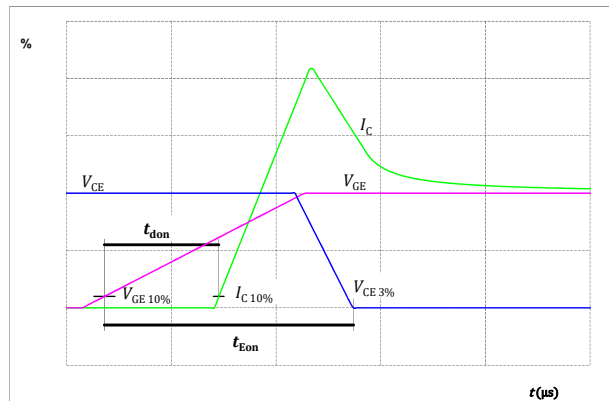


figure 54. IGBT

Turn-off Switching Waveforms & definition of  $t_f$

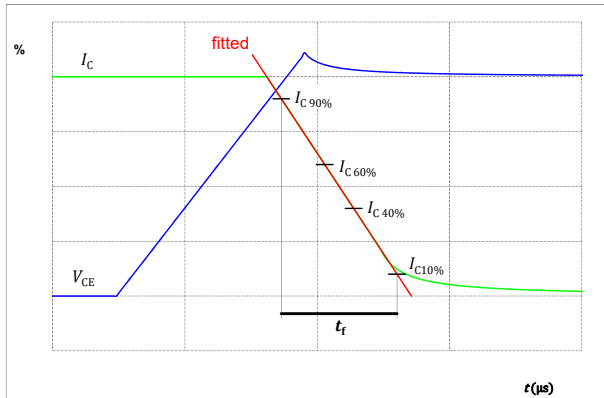
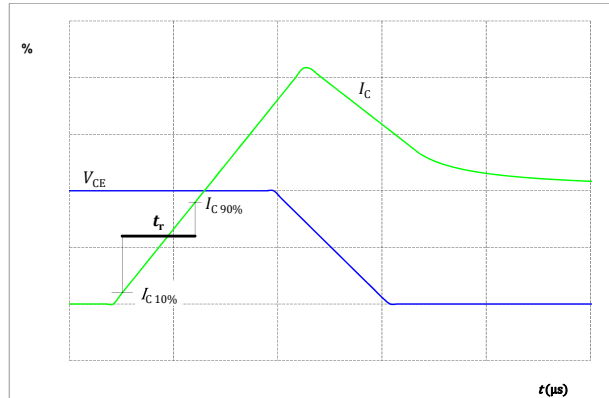


figure 55. IGBT

Turn-on Switching Waveforms & definition of  $t_r$





### Switching Definitions

figure 56. FWD

Turn-off Switching Waveforms & definition of  $t_{rr}$

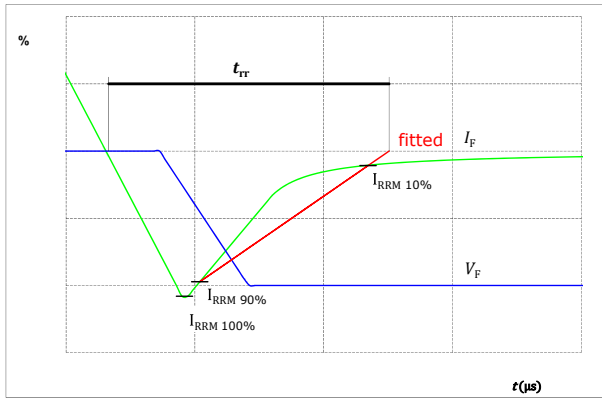
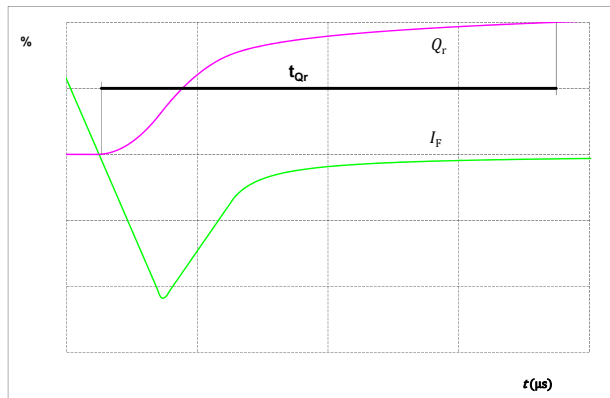


figure 57. FWD

Turn-on Switching Waveforms & definition of  $t_{Qr}$  ( $t_{Qr}$  = integrating time for  $Q_r$ )






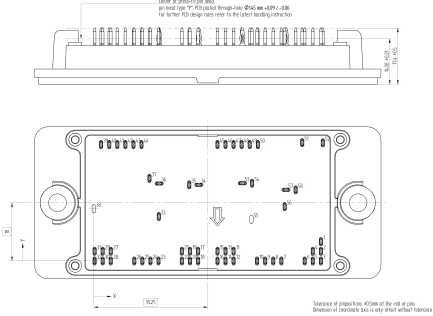
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**30-PT07NIB300S503-LH36F58Y**  
datasheet

| Ordering Code                         |                                |
|---------------------------------------|--------------------------------|
| <b>Version</b>                        | <b>Ordering Code</b>           |
| Without thermal paste                 | 30-PT07NIB300S503-LH36F58Y     |
| With thermal paste (3,4 W/mK, PSX-P7) | 30-PT07NIB300S503-LH36F58Y-/3/ |

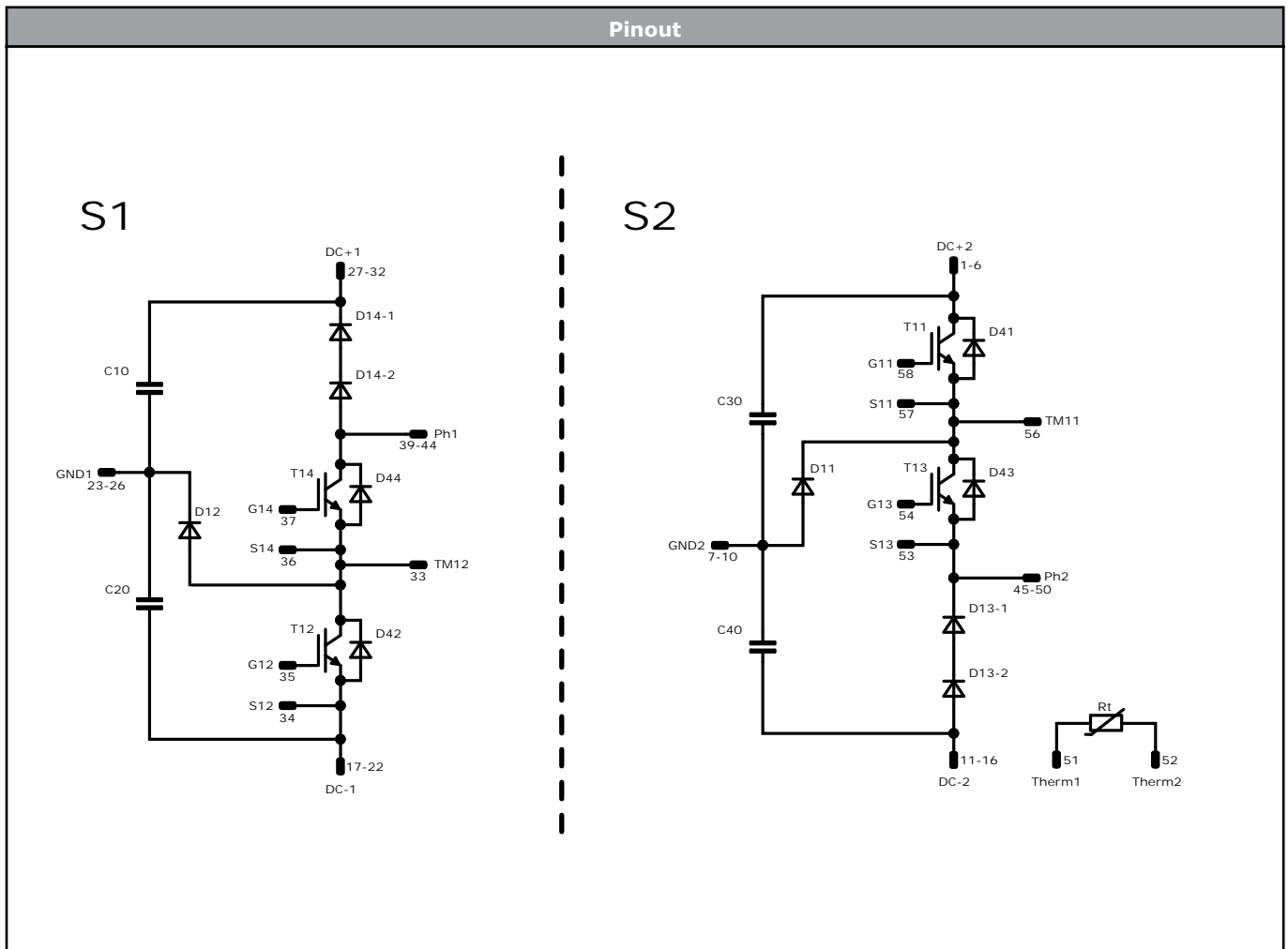
| Marking   |                   |  |                            |                               |                          |                       |
|---|-------------------|--|----------------------------|-------------------------------|--------------------------|-----------------------|
|  | <b>Text</b>       | <b>Name</b><br>NN-NNNNNNNNNNNNNN-<br>TTTTTVV | <b>Date code</b><br>WWYY   | <b>UL &amp; VIN</b><br>UL VIN | <b>Lot</b><br>LLLLL      | <b>Serial</b><br>SSSS |
|   | <b>Datamatrix</b> | <b>Type&amp;Ver</b><br>TTTTTVV               | <b>Lot number</b><br>LLLLL | <b>Serial</b><br>SSSS         | <b>Date code</b><br>WWYY |                       |

| Outline        |       |   |          |    |               |       |        |
|----------------|-------|---|----------|----|---------------|-------|--------|
| Pin table [mm] |       |   |          |    |               |       |        |
| Pin            | X     | Y | Function | 30 | 2,75          | 0     | DC+1   |
| 1              | 70,25 | 6 | DC+2     | 31 | 0,25          | 3     | DC+1   |
| 2              | 70,25 | 3 | DC+2     | 32 | 0,25          | 0     | DC+1   |
| 3              | 70,25 | 0 | DC+2     | 33 | 20,1          | 13,75 | TM12   |
| 4              | 67,75 | 3 | DC+2     | 34 | 32,5          | 23,55 | S12    |
| 5              | 67,75 | 0 | DC+2     | 35 | 29,5          | 23,55 | G12    |
| 6              | 65,25 | 0 | DC+2     | 36 | 20,2          | 23,95 | S14    |
| 7              | 58    | 0 | GND2     | 37 | 17,2          | 25,55 | G14    |
| 8              | 55,5  | 0 | GND2     | 38 | not assembled |       |        |
| 9              | 53    | 0 | GND2     | 39 | 2,25          | 36    | Ph1    |
| 10             | 50,5  | 0 | GND2     | 40 | 4,75          | 36    | Ph1    |
| 11             | 43,25 | 3 | DC-2     | 41 | 7,25          | 36    | Ph1    |
| 12             | 43,25 | 0 | DC-2     | 42 | 9,75          | 36    | Ph1    |
| 13             | 40,75 | 3 | DC-2     | 43 | 12,25         | 36    | Ph1    |
| 14             | 40,75 | 0 | DC-2     | 44 | 14,75         | 36    | Ph1    |
| 15             | 38,25 | 3 | DC-2     | 45 | 38,25         | 36    | Ph2    |
| 16             | 38,25 | 0 | DC-2     | 46 | 40,75         | 36    | Ph2    |
| 17             | 32,25 | 3 | DC-1     | 47 | 43,25         | 36    | Ph2    |
| 18             | 32,25 | 0 | DC-1     | 48 | 45,75         | 36    | Ph2    |
| 19             | 29,75 | 3 | DC-1     | 49 | 48,25         | 36    | Ph2    |
| 20             | 29,75 | 0 | DC-1     | 50 | 50,75         | 36    | Ph2    |
| 21             | 27,25 | 3 | DC-1     | 51 | 64,45         | 36,6  | Therm1 |
| 22             | 27,25 | 0 | DC-1     | 52 | 70,85         | 36,55 | Therm2 |
| 23             | 20    | 0 | GND1     | 53 | 45,95         | 24,05 | S13    |
| 24             | 17,5  | 0 | GND1     | 54 | 48,95         | 24,05 | G13    |
| 25             | 15    | 0 | GND1     | 55 | not assembled |       |        |
| 26             | 12,5  | 0 | GND1     | 56 | 59,05         | 16,8  | TM11   |
| 27             | 5,25  | 3 | DC+1     | 57 | 59,45         | 22    | S11    |
| 28             | 5,25  | 0 | DC+1     | 58 | 62,45         | 22    | G11    |
| 29             | 2,75  | 3 | DC+1     |    |               |       |        |





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| Identification     |            |         |         |                            |         |
|--------------------|------------|---------|---------|----------------------------|---------|
| ID                 | Component  | Voltage | Current | Function                   | Comment |
| T11, T12           | IGBT       | 650 V   | 300 A   | Buck Switch                |         |
| D11, D12           | FWD        | 650 V   | 280 A   | Buck Diode                 |         |
| D41, D42           | FWD        | 1200 V  | 8 A     | Buck Sw. Protection Diode  |         |
| T13, T14           | IGBT       | 650 V   | 225 A   | Boost Switch               |         |
| D13, D14           | FWD        | 1300 V  | 280 A   | Boost Diode                |         |
| D43, D44           | FWD        | 1200 V  | 8 A     | Boost Sw. Protection Diode |         |
| C10, C20, C30, C40 | Capacitor  | 630 V   |         | Capacitor (DC)             |         |
| Rt                 | Thermistor |         |         | Thermistor                 |         |




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| Packaging instruction                |      |          |      |        |
|--------------------------------------|------|----------|------|--------|
| Standard packaging quantity (SPQ) 36 | >SPQ | Standard | <SPQ | Sample |

| Handling instruction  |
|---|
| Handling instructions for <i>flow 2</i> packages see vincotech.com website. |

| Package data   |
|--|
| Package data for <i>flow 2</i> packages see vincotech.com website. |

| Vincotech thermistor reference                                     |
|--|
| See Vincotech thermistor reference table at vincotech.com website. |

| UL recognition and file number  |
|---|
| This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.  |

| Document No.:                    | Date:       | Modification:   | Pages |
|----------------------------------|-------------|---|-------|
| 30-PT07NIB300S503-LH36F58Y-D4-14 | 2 Mar. 2023 | New Datasheet format<br>Separate datasheet<br>Isolation voltage update<br>Diode change<br>TM14, TM15 pins removal |       |

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.